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|-----------------------------------|---------------------------------------|--|-------------|
| <b>Notice of References Cited</b> | Application/Control No.<br>10/594,654 | Applicant(s)/Patent Under Reexamination<br>BUCK ET AL. |             |
|                                   | Examiner<br>Sin J. Lee                | Art Unit<br>1722                                       | Page 1 of 1 |

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|   | C | US-  |                 |                  |                |
|   | D | US-  |                 |                  |                |
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|   | F | US-  |                 |                  |                |
|   | G | US-  |                 |                  |                |
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|   | J | US-  |                 |                  |                |
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|   | L | US-  |                 |                  |                |
|   | M | US-  |                 |                  |                |

**FOREIGN PATENT DOCUMENTS**

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\*A copy of this reference is not being furnished with this Office action. (See MPEP § 707.05(a).)  
Dates in MM-YYYY format are publication dates. Classifications may be US or foreign.